

8A, 60V Trench Schottky Rectifiers

FEATURES

- AEC-Q101 qualified
- Patented Trench Schottky technology
- Low power loss, high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

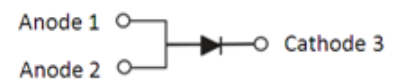
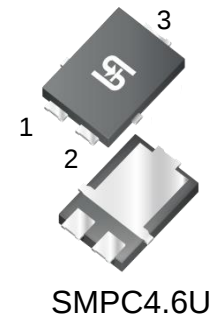
KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	8	A
V_{RRM}	60	V
I_{FSM}	150	A
$T_{J\ MAX}$	175	°C
Package	SMPC4.6U	

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter
- Automotive

MECHANICAL DATA

- Case: SMPC4.6U
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 104mg (approximately)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)				
PARAMETER		SYMBOL	TSUP8M60SH	UNIT
Marking code on the device			8M60	
Repetitive peak reverse voltage		V_{RRM}	60	V
Reverse voltage, total rms value		$V_{R(RMS)}$	42	V
Forward current		I_F	8	A
Surge peak forward current single half sine-wave superimposed on rated load	8.3 ms at $T_A = 25^\circ\text{C}$	I_{FSM}	150	A
	1.0 ms at $T_A = 25^\circ\text{C}$		297	
Junction temperature		T_J	-55 to +175	°C
Storage temperature		T_{STG}	-55 to +175	°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	7	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	56	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	12	°C/W

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 4.0\text{A}, T_J = 25^\circ\text{C}$	V_F	0.53	-	V
	$I_F = 8.0\text{A}, T_J = 25^\circ\text{C}$		0.61	0.64	V
	$I_F = 4.0\text{A}, T_J = 125^\circ\text{C}$		0.44	-	V
	$I_F = 8.0\text{A}, T_J = 125^\circ\text{C}$		0.56	0.61	V
Reverse current @ rated V_R ⁽²⁾	$T_J = 25^\circ\text{C}$	I_R	-	600	μA
	$T_J = 125^\circ\text{C}$		-	7	mA
Junction capacitance	1 MHz, $V_R = 4.0\text{V}$	C_J	547	-	pF

Notes:

1. Pulse test with $PW = 0.3\text{ ms}$
2. Pulse test with $PW = 30\text{ ms}$

ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
TSUP8M60SH M3G	SMPC4.6U	1,500/7" reel
TSUP8M60SH M2G	SMPC4.6U	6,000/13" reel

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

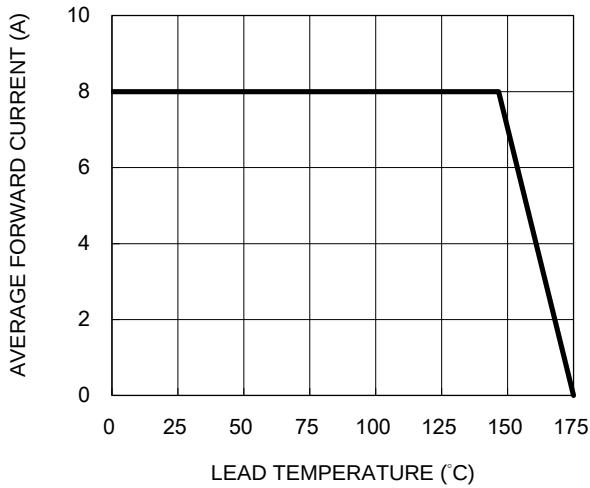


Fig.2 Typical Junction Capacitance

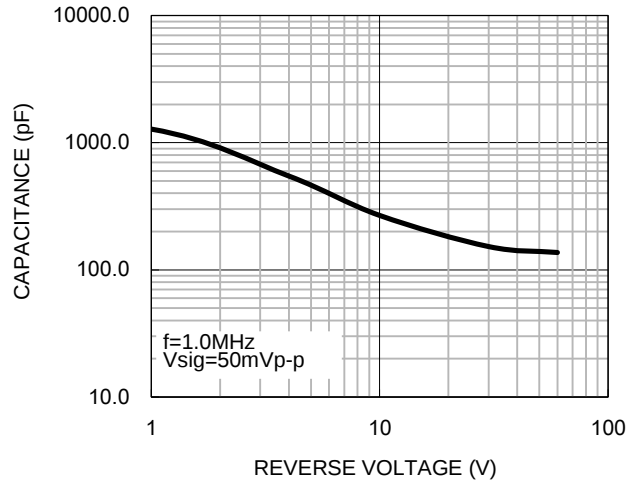


Fig.3 Typical Reverse Characteristics

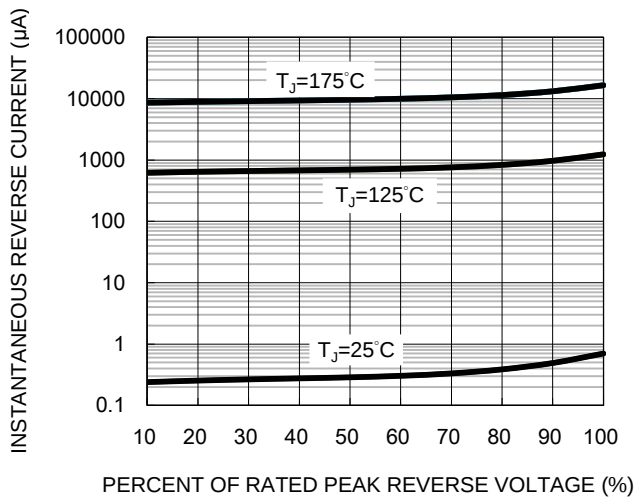


Fig.4 Typical Forward Characteristics

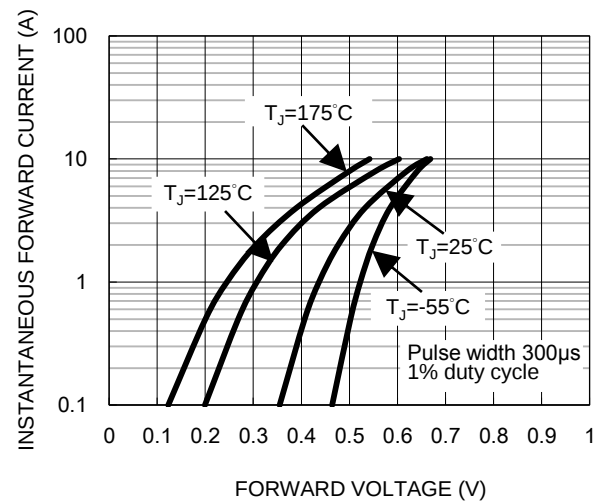
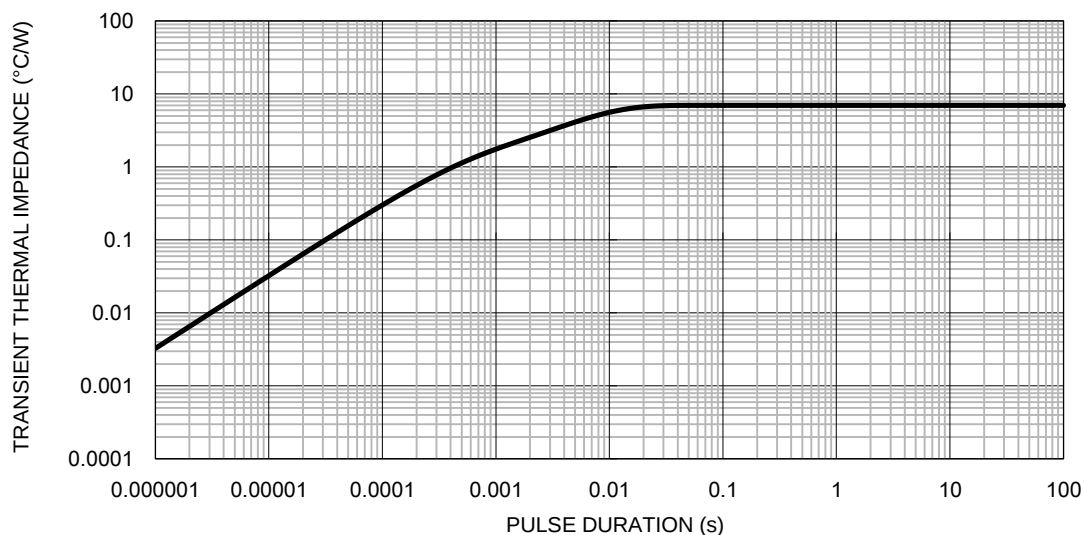
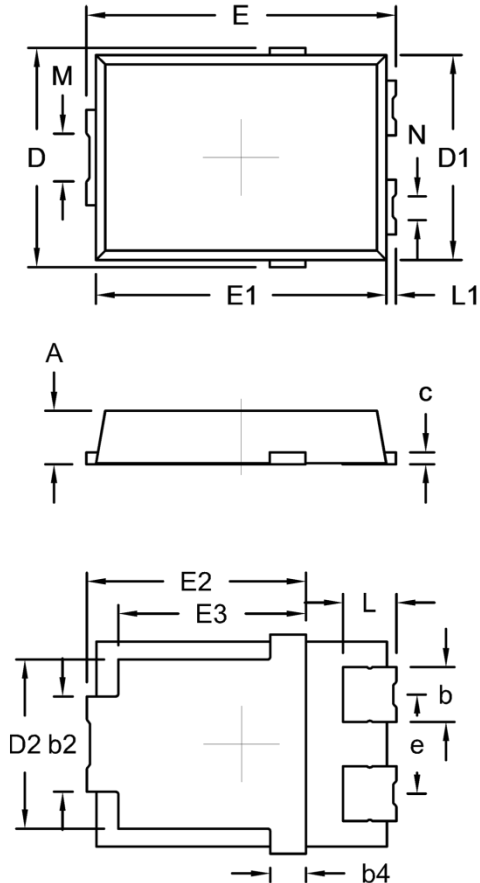


Fig.5 Typical Transient Thermal Impedance

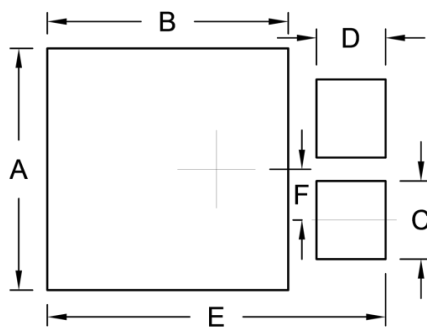


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

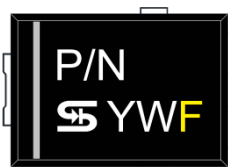
SMPC4.6U


DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	1.00	1.20	0.039	0.047
b	1.05	1.35	0.041	0.053
b2	1.90	2.20	0.075	0.087
b4	0.75 (NOM.)		0.030 (NOM.)	
c	0.15	0.40	0.006	0.016
D	4.45	4.75	0.175	0.187
D1	4.25	4.35	0.167	0.171
D2	3.40	3.70	0.134	0.146
E	6.35	6.65	0.250	0.262
E1	6.05	6.15	0.238	0.242
E2	4.40	4.80	0.173	0.189
E3	3.94 (NOM.)		0.155 (NOM.)	
e	2.08 (NOM.)		0.082 (NOM.)	
L	0.94	1.24	0.037	0.049
L1	0.05	0.35	0.002	0.014
M	0.65	1.15	0.026	0.045
N	0.25	0.75	0.010	0.030

Package body size D1 and E1 do not include mold flash
 Mold flash shall not exceed 0.1mm per side

SUGGESTED PAD LAYOUT


Symbol	Unit (mm)	Unit (inch)
A	4.95	0.195
B	4.95	0.195
C	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

MARKING DIAGRAM


P/N = Marking Code
 YW = Date Code
 F = Factory Code

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